

**Features**

- ➔ 1500MHz - 3000MHz
- ➔ 14.8 dB Gain at 2.3GHz
- ➔ +25 dBm P1dB
- ➔ +42 dBm Output IP3
- ➔ Single Voltage Supply
- ➔ Lead-free / Green / RoHS-compliant SOT-89 Package

**Applications**

- ➔ Mobile Infrastructure
- ➔ PCS, WCDMA, WiBro
- ➔ W-LAN / ISM
- ➔ RFID / Fixed Wireless

**Functional Diagram**


Function	Pin No.
RF IN	1
RF OUT / Bias	3
Ground	2,4

**Description**

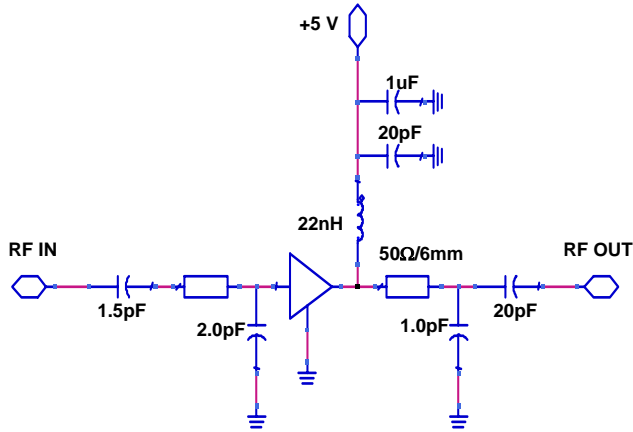
The PH435 is a high performance InGaP HBT MMIC Amplifier and high linearity driver amplifier in a high quality SOT-89 package. The device features excellent Input and output return loss, highly linear performance. The device can be easily matched to obtain optimum power and linearity. The product is targeted for use as driver amplifier for wireless infrastructure applications. The PH435 operates from a single +5 voltage supply and have an internal active bias. All devices are 100% RF and DC tested

**Specifications**

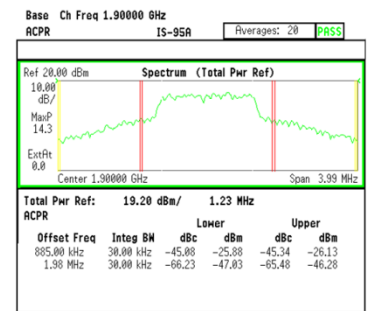
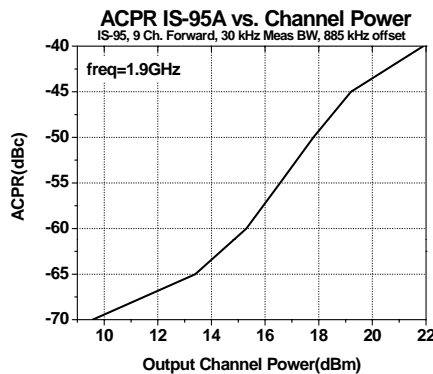
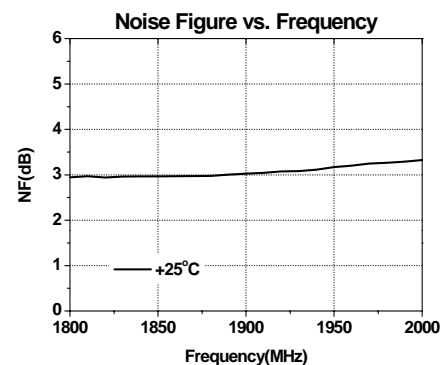
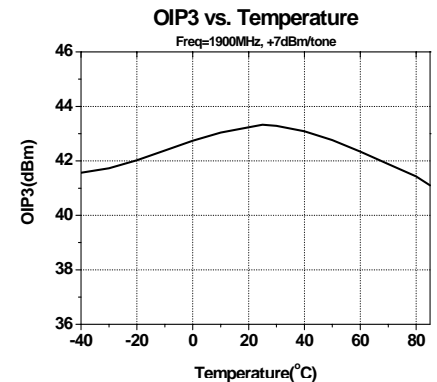
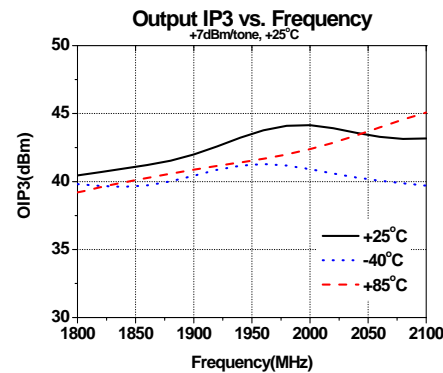
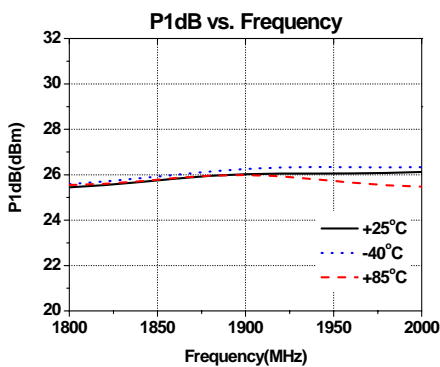
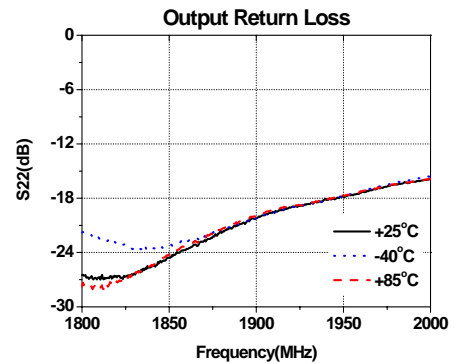
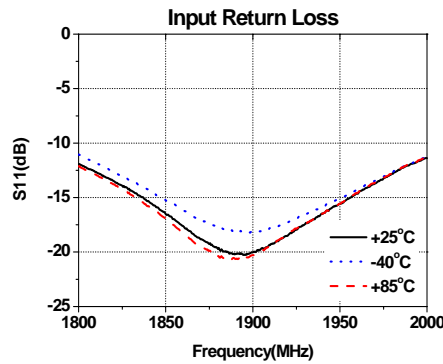
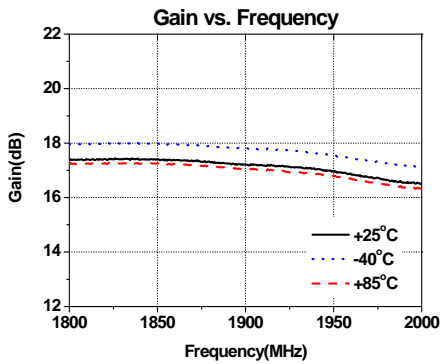
Symbol	Parameters	Units	Freq.	Min.	Typ.	Max.
S21	Gain	dB	1900 MHz 2140 MHz 2300 MHz		16.8 15.1 14.8	
S11	Input Return Loss	dB	1900 MHz 2140 MHz 2300 MHz		-17 -17 -14	
S22	Output Return Loss	dB	1900 MHz 2140 MHz 2300 MHz		-17 -14 -14	
P1dB	Output Power @1dB compression	dBm	1900 MHz 2140 MHz 2300 MHz		25.5 25.5 25.5	
OIP3	Output Third Order intercept	dBm	1900 MHz 2140 MHz 2300 MHz		42.0 42.0 42.5	
NF	Noise Figure	dB	1900 MHz 2140 MHz 2300 MHz		3.1 3.0 3.2	
V / I	Device voltage / current	V/mA			5/152	
Rth	Thermal Resistance	°C/W			53	
Tj	Junction Temperature	°C			125	

Test Conditions : T=25°C, Supply Voltage=+5V, 50ohm System, OIP3 measured with two tones at an output power of +7dBm/tone separated by 1MHz.

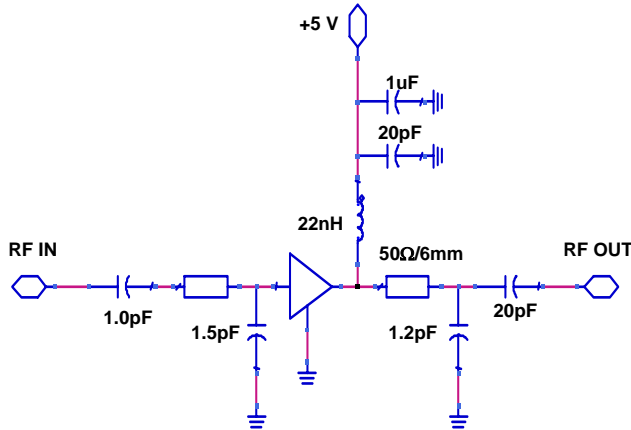
### 1900 MHz Application Circuit



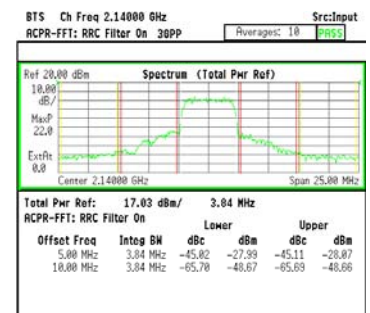
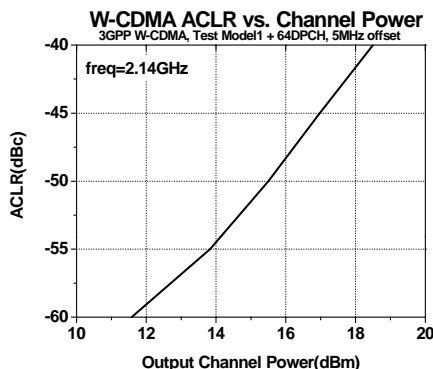
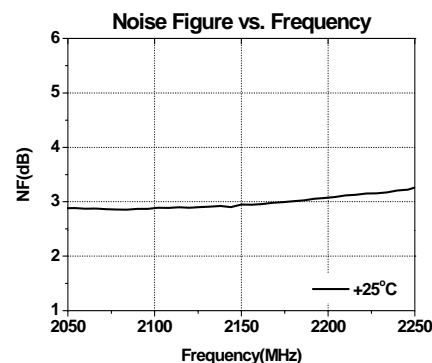
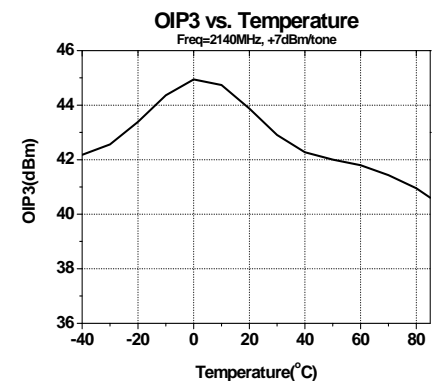
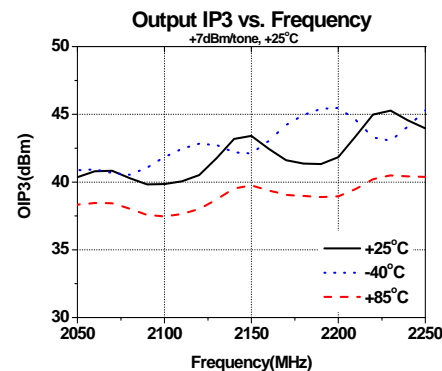
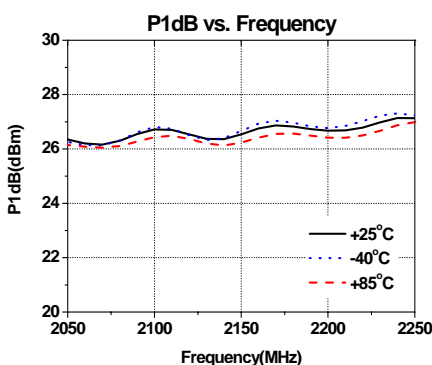
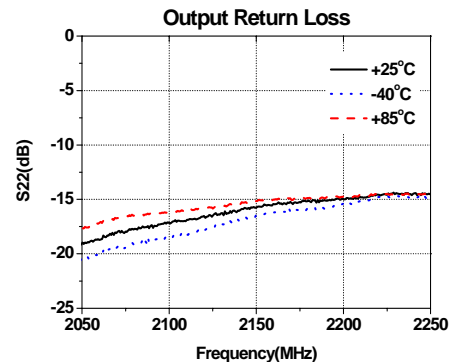
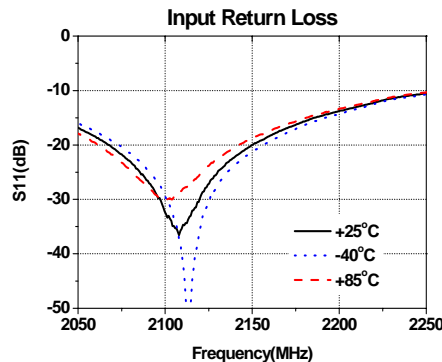
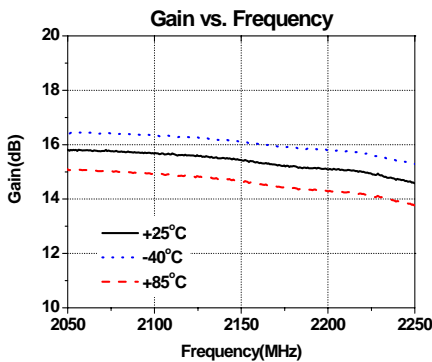
Frequency	1900 MHz
S21 : Gain	17.0 dB
S11 : Input Return Loss	-19 dB
S22 : Output Return Loss	-19 dB
Output P1dB	+25.5 dBm
Output IP3 @7dBm	+42 dBm
IS-95A Ch. Power @ -45dBc ACPR	+19.0 dBm
Noise Figure	3.1 dB
Supply Voltage	5 V
Current	152 mA



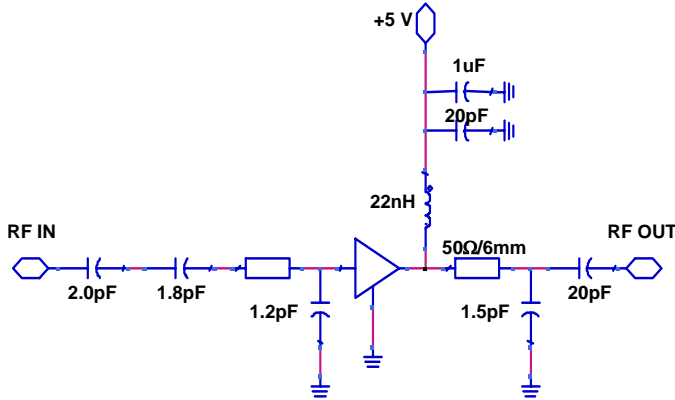
### 2140 MHz Application Circuit



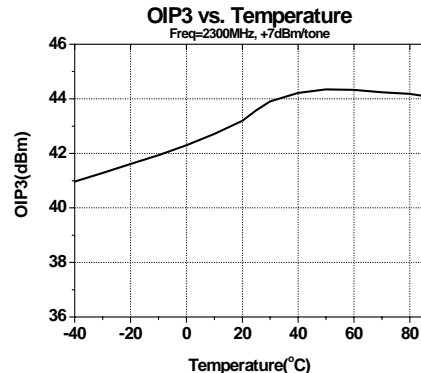
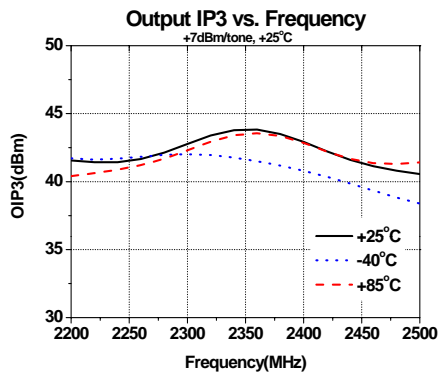
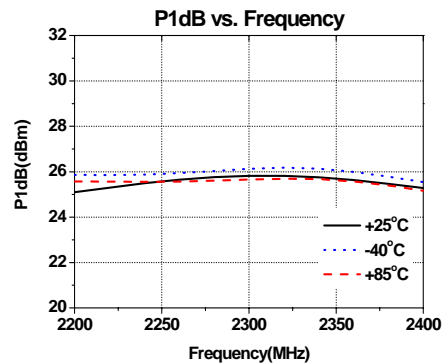
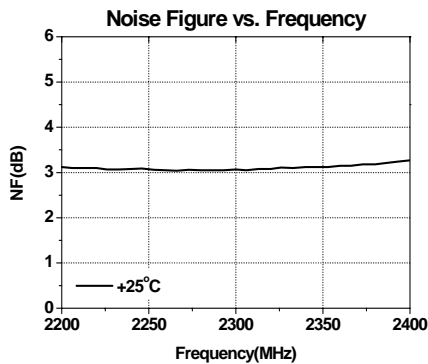
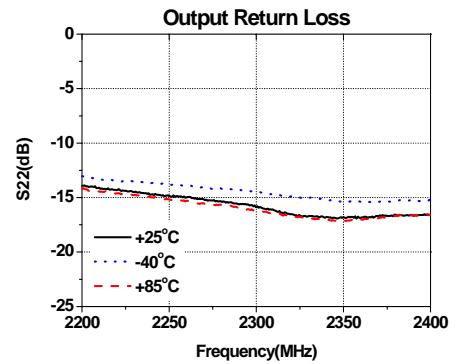
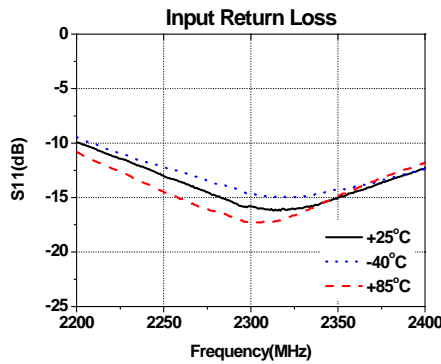
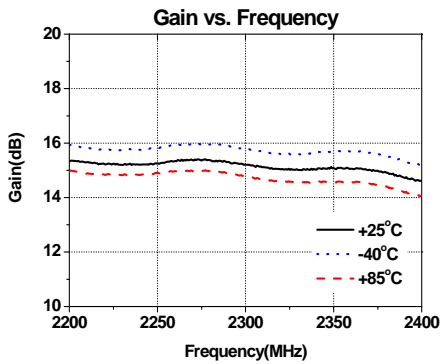
Frequency	2140 MHz
S21 : Gain	15.4 dB
S11 : Input Return Loss	-20 dB
S22 : Output Return Loss	-16 dB
Output P1dB	+26.0 dBm
Output IP3 @7dBm	+42 dBm
WCDMA Ch. Power @ -45dBc ACLR	+17.0 dBm
Noise Figure	3.0 dB
Supply Voltage	5 V
Current	152 mA



### 2300 MHz Application Circuit



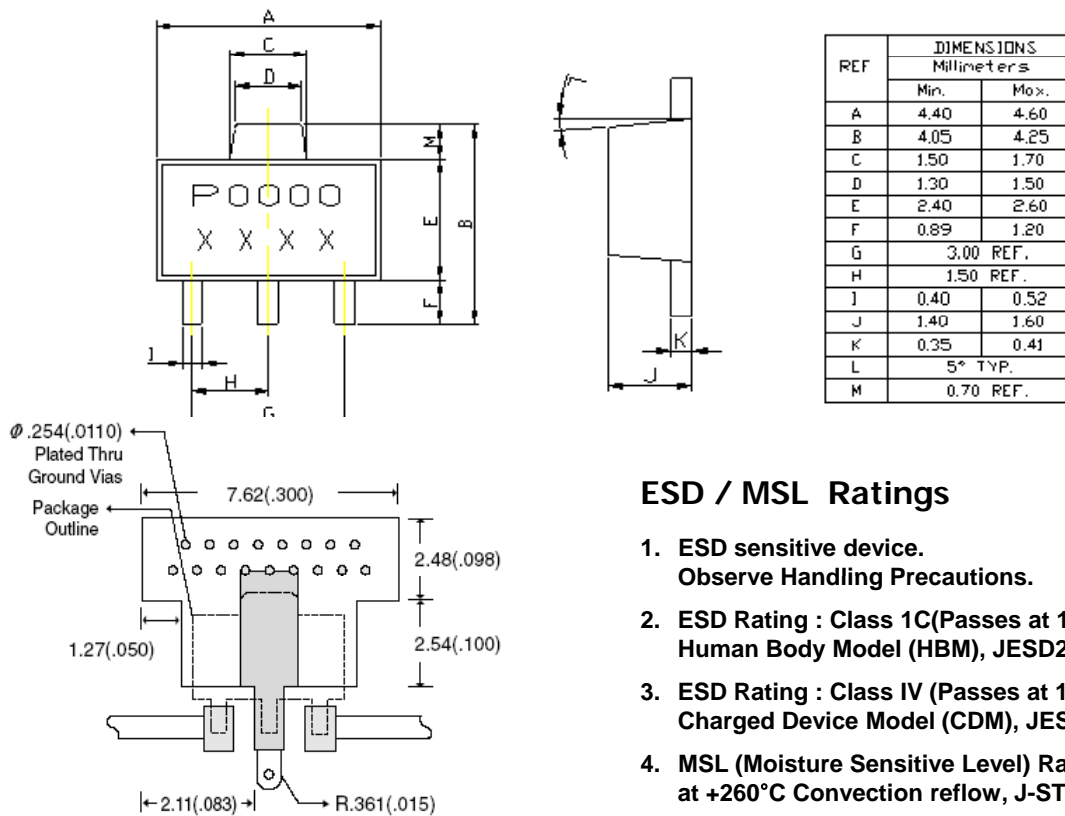
Frequency	2300 MHz
S21 : Gain	15.0 dB
S11 : Input Return Loss	-15 dB
S22 : Output Return Loss	-15 dB
Output P1dB	+25.5 dBm
Output IP3 @7dBm	+42.5 dBm
Noise Figure	3.1 dB
Supply Voltage	5 V
Current	152 mA



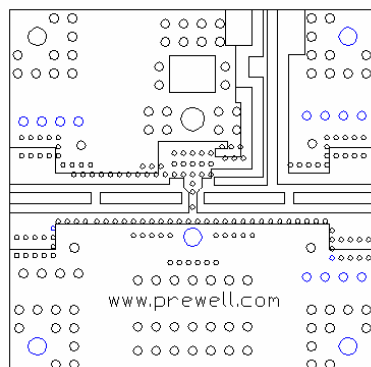
**Absolute Maximum Ratings**

Parameter	Rating	Unit
Supply Voltage	+6	V
Supply Current	220	mA
RF Power Input	12	dBm
Storage Temperature	-55 to +125	°C
Ambient Operating Temperature	-40 to +85	°C
Junction Temperature	230	°C

Operation of this device above any of these parameters may cause permanent damage.

**Lead-free /RoHS Compliant / Green SOT-89 Package Outline**

**ESD / MSL Ratings**

- ESD sensitive device. Observe Handling Precautions.
- ESD Rating : Class 1C(Passes at 1000V min.) Human Body Model (HBM), JESD22-A114
- ESD Rating : Class IV (Passes at 1000V min.) Charged Device Model (CDM), JESD22-C101
- MSL (Moisture Sensitive Level) Rating : Level 3 at +260°C Convection reflow, J-STD-020

**Evaluation Board Layout (4x4)**

**Mounting Instructions**

- Use a large ground pad area with many plated through-holes as shown.
- We recommend 1 oz copper minimum.
- Measurement for our data sheet was made on 0.8mm thick FR-4 Board.
- Add as much copper as possible to inner and outer layers near the part to ensure optimal thermal performance.
- RF trace width depends on the board material and construction.
- Add mounting screws near the part to fasten the board to a heatsink.

<http://www.prewell.com>